DISCRETE SEMICONDUCTORS



Product specification

August 1986



BLV11

DESCRIPTION

N-P-N silicon planar epitaxial transistor intended for use in class-A, B and C operated mobile, h.f. and v.h.f. transmitters with a nominal supply voltage of 13,5 V. The transistor is resistance stabilized and is guaranteed to withstand severe load mismatch conditions with a supply over-voltage to 16,5 V. It has a 3/8" flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

R.F. performance up to T_h = 25 °C in an unneutralized common-emitter class-B circuit

MODE OF OPERATION	V _{CE} V	f MHz	P _L W	G _p dB	η %	z̄ _i Ω	₩S
C.W.	13,5	175	15	> 8,0	> 60	2,3 + j2,2	130 – j4,4
C.W.	12,5	175	15	typ. 7,5	typ. 67	_	-

PINNING

PIN CONFIGURATION



PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

36 V

18 V

4 V

3 A

8 A

36 W

-65 to + 150 °C

max.

max.

max.

max.

max.

max.

VHF power transistor

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RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

peak value	VCESM
Collector-emitter voltage (open base)	V_{CEO}
Emitter-base voltage (open collector)	V_{EBO}
Collector current (average)	I _{C(AV)}
Collector current (peak value); f > 1 MHz	I _{CM}
R.F. power dissipation (f > 1 MHz); T_{mb} = 25 °C	P _{rf}
Storage temperature	T _{stg}

Operating junction temperature



THERMAL RESISTANCE

(dissipation = 15 W; T_{mb} = 74,5 °C, i.e. T_h = 70 °C)

From junction to mounting base (d.c. dissipation) From junction to mounting base (r.f. dissipation) From mounting base to heatsink



R _{th j-mb(dc)}	=	6,55 K/W
R _{th j-mb(rf)}	=	4,95 K/W
R _{th mb-h}	=	0,3 K/W

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CHARACTERISTICS				
T _j = 25 °C				
Collector-emitter breakdown voltage				
V _{BE} = 0; I _C = 10 mA	V _{(BR)CES}	>	36	V
Collector-emitter breakdown voltage				
open base; I _C = 50 mA	V _{(BR)CEO}	>	18	V
Emitter-base breakdown voltage				
open collector; I _E = 4 mA	V _{(BR)EBO}	>	4	V
Collector cut-off current				
V _{BE} = 0; V _{CE} = 18 V	I _{CES}	<	4	mA
Second breakdown energy; L = 25 mH; f = 50 Hz				
open base	E _{SBO}	>	2,5	mJ
R _{BE} = 10 Ω	E _{SBR}	>	2,5	mJ
D.C. current gain ⁽¹⁾		typ.	40	
$I_{C} = 1,5 \text{ A}; V_{CE} = 5 \text{ V}$	h _{FE}	10 to	100	
Collector-emitter saturation voltage ⁽¹⁾				
I _C = 4,5 A; I _B = 0,9 A	V _{CEsat}	typ.	1,0	V
Transition frequency at $f = 100 \text{ MHz}^{(1)}$				
-I _E = 1,5 A; V _{CB} = 13,5 V	f _T	typ.	850	MHz
–I _E = 4,5 A; V _{CB} = 13,5 V	f _⊤	typ.	800	MHz
Collector capacitance at f = 1 MHz				
I _E = I _e = 0; V _{CB} = 13,5 V	C _c	typ.	32	pF
Feedback capacitance at f = 1 MHz				
I _C = 200 mA; V _{CE} = 13,5 V	C _{re}	typ.	23	pF
Collector-flange capacitance	C _{cf}	typ.	2	pF

Note

1. Measured under pulse conditions: $t_p \leq 200 \ \mu s; \ \delta \leq 0,02.$





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 $-I_{\mathsf{E}}(\mathsf{A})$

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APPLICATION INFORMATION

R. F. performance in c.w. operation (unneutralized common-emitter class-B circuit) T_{h} = 25 $^{\circ}\text{C}$

f (MHz)	V _{CE} (V)	P _L (W)	P _S (W)	G _p (dB)	I _C (A)	η (%)	 Ζ _i (Ω)	\overline{Y}_{L} (mS)
175	13,5	15	< 2,4	> 8,0	< 1,85	> 60	2,3 + j2,2	130 – j4,4
175	12,5	15	-	typ. 7,5	-	typ. 67	_	_



List of components:

C1 = 2,5 to 20 pF film dielectric trimmer (cat. no. 2222 809 07004)

C2 = C6 = 4 to 40 pF film dielectric trimmer (cat. no. 2222 809 07008)

C3 = 47 pF ceramic capacitor (500 V)

- C4 = 120 pF ceramic capacitor (500 V)
- C5 = 100 nF polyester capacitor

C7 = 5 to 60 pF film dielectric trimmer (cat. no. 2222 809 07011)

L1 = 2 turns Cu wire (1,6 mm); int. dia. 4,5 mm; length 5,7 mm; leads 2×5 mm

L2 = L6 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

 $L3 = L4 = strip (12 mm \times 6 mm);$ tap for C3 at 5 mm from transistor

L5 = 3 turns Cu wire (1,6 mm); int. dia. 7,5 mm; length 7,5 mm; leads 2×5 mm

L7 = 3 turns Cu wire (1,6 mm); int. dia. 6,5 mm; length 7,4 mm; leads 2×5 mm

L3 and L4 are strips on a double Cu-clad printed-circuit board with epoxy fibre-glass dielectric, thickness 1/16".

R1 = 10 Ω carbon resistor

Component layout and printed-circuit board for 175 MHz test circuit see Fig.8.

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The circuit and the components are situated on one side of the epoxy fibre-glass board, the other side being fully metallized to serve as earth. Earth connections are made by means of hollow rivets, whilst under the emitter leads Cu straps are used for a direct contact between upper and lower sheets.

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Fig.11 R.F. SOAR (short-time operation during mismatch); f = 175 MHz; $T_h = 70 \text{ °C}$; R_{th mb-h} = 0,3 K/W; V_{CEnom} = 13,5 V or 12,5 V; P_S = P_{Snom} at V_{CEnom} and VSWR = 1.









OPERATING NOTE

Below 50 MHz a base-emitter resistor of 10 Ω is recommended to avoid oscillation. This resistor must be effective for r.f. only.

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads



SOT123A

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Product specification

DEFINITIONS

Data Sheet Status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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